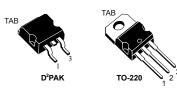
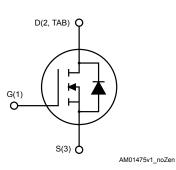


## Datasheet

# N-channel 600 V, 0.4 Ω typ., 11 A, MDmesh™ II Power MOSFETs in D²PAK and TO-220 packages





## **Features**

Order codes	V <sub>DSS</sub> (@ T <sub>Jmax</sub> )	R <sub>DS(on)</sub> max.	Ι <sub>D</sub>	Package
STB11NM60T4	650 V 0.45 Ω	0.45.0	11 A	D <sup>2</sup> PAK
STP11NM60			TO-220	

• 100% avalanche tested

- Low input capacitance and gate charge
- Low gate input resistance

## **Applications**

Switching applications

# Description

These devices are N-channel Power MOSFETs developed using the second generation of MDmesh<sup>™</sup> technology. These revolutionary Power MOSFETs associate a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. They are therefore suitable for the most demanding high-efficiency converters.

Product status link				
STB11NM60T4				
STP11NM60				
Product	summary			
Order code	STB11NM60T4			
Marking	B11NM60			
Package D <sup>2</sup> PAK				
Packing	Tape and reel			

Order code Marking

Package

Packing

STP11NM60

P11NM60 TO-220

Tube



# 1 Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Gate-source voltage	600	V
V <sub>GS</sub>	Gate- source voltage	±30	V
۱ <sub>D</sub>	Drain current (continuous) at $T_C$ = 25 °C	11	А
۱ <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	7	A
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	44	А
P <sub>TOT</sub>	Total dissipation at $T_C$ = 25 °C	160	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
T <sub>stg</sub>	Storage temperature range	-65 to 150	°C
Тj	T <sub>j</sub> Operating junction temperature range		

#### Table 1. Absolute maximum ratings

1. Pulse width limited by safe operating area.

2.  $I_{SD} \leq 11$  A,  $di/dt \leq 400$  A/ $\mu$ s,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_j \leq T_{JMAX}$ .

## Table 2. Thermal data

Symbol	Parameter	Va	Unit		
Symbol	Falameter	D <sup>2</sup> PAK	TO-220	Unit	
R <sub>thj-case</sub>	Thermal resistance junction-case	0.			
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5			
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	35			

1. When mounted on 1inch<sup>2</sup> FR-4 board, 2 oz Cu.

#### Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or non-repetitive (pulse width limited by ${\rm T}_{\rm jmax})$	5.5	А
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V)	350	mJ



# 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A	600			V
		$V_{GS}$ = 0 V, $V_{DS}$ = 600 V			1	μA
I <sub>DSS</sub>	I <sub>DSS</sub> Zero gate voltage drain current	$V_{GS}$ = 0 V, $V_{DS}$ = 600 V, T <sub>C</sub> = 125 °C <sup>(1)</sup>			10	μA
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS}$ = 0 V, $V_{GS}$ = ±30 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.5 A		0.4	0.45	Ω

#### Table 4. On/off states

1. Defined by design, not subject to production test.

## Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	1000	-	pF
C <sub>oss</sub>	Output capacitance	$V_{DS}$ = 25 V, f = 1 MHz, $V_{GS}$ = 0 V	-	230	-	pF
C <sub>rss</sub>	Reverse transfer capacitance		-	25	-	pF
C <sub>oss eq.</sub> <sup>(1)</sup>	Equivalent output capacitance	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V	-	100	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.6	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 11 A,	-	30	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	10	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 12. Test circuit for gate charge behavior)	-	15	-	nC

 C<sub>oss eq.</sub> is defined as a constant equivalent capacitance giving the same charging time as C<sub>oss</sub> when V<sub>DS</sub> increases from 0 to 80% V<sub>DSS</sub>

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}$ = 300 V, I <sub>D</sub> = 5.5 A,	-	20	-	ns
tr	Rise time	$R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10 V (see Figure 11. Test circuit for resistive load switching times and Figure 16. Switching time waveform)	_	20	-	ns
t <sub>r(Voff)</sub>	Off-voltage rise time	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 11 A,	-	6	-	ns
t <sub>f</sub>	Fall time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see	-	11	-	ns
t <sub>c</sub>	Cross-over time	Figure 13. Test circuit for inductive load switching and diode recovery times and Figure 16. Switching time waveform)	-	19	-	ns

#### Table 6. Switching times

5.7

20

-

\_

Unit

А

А

V ns μC

А

ns

μC

А

Symbol	Parameter	Test conditions	Min.	Тур.	Max.
I <sub>SD</sub>	Source-drain current		-		11
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		44
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$V_{GS}$ = 0 V, I <sub>SD</sub> = 11 A	-		1.5
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 11 A, di/dt = 100 A/µs,	-	390	
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 100 V	-	3.8	
I <sub>RRM</sub>	Reverse recovery current	(see Figure 13. Test circuit for inductive load switching and diode recovery times)	-	19.5	
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 11 A, di/dt = 100 A/µs,	-	570	

 $V_{DD}$  = 100 V, T<sub>j</sub> = 150 °C

recovery times)

(see Figure 13. Test circuit for inductive load switching and diode

#### Table 7. Source drain diode

1. Pulse width is limited by safe operating area

Qrr

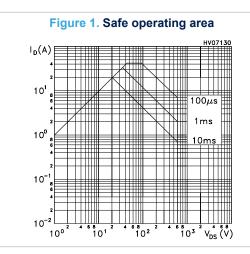
I<sub>RRM</sub>

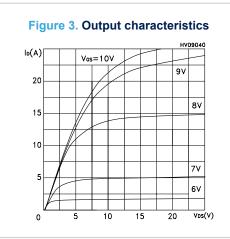
2. Pulse test: pulse duration =  $300 \ \mu$ s, duty cycle 1.5%

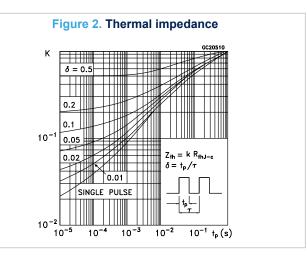
Reverse recovery charge

Reverse recovery current

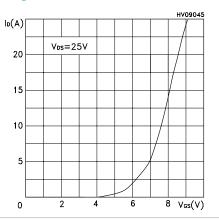
# 2.1 Electrical characteristics (curves)

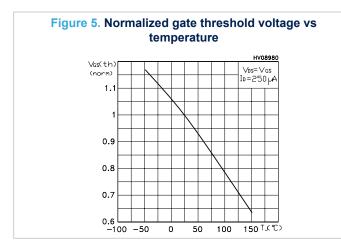




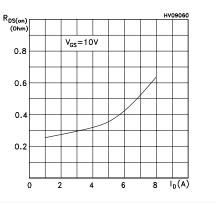


## Figure 4. Transfer characteristics

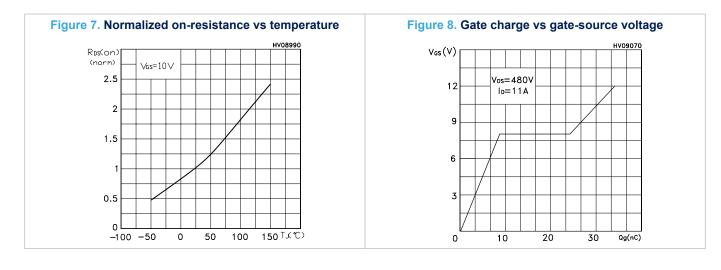


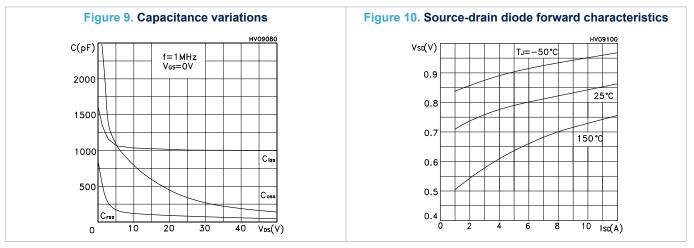






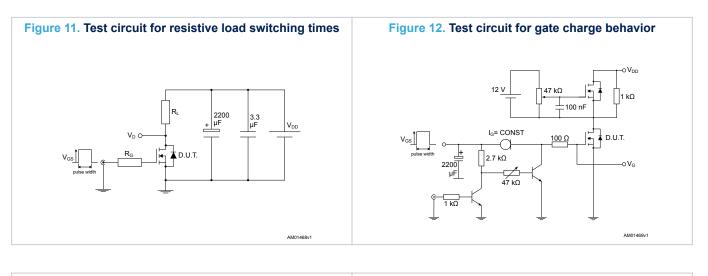


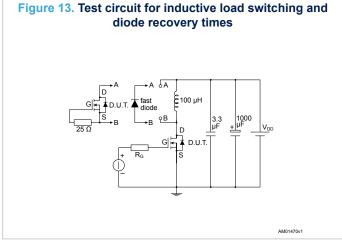


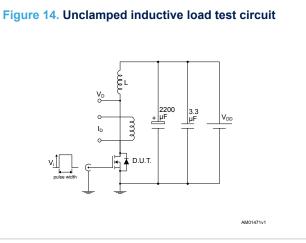


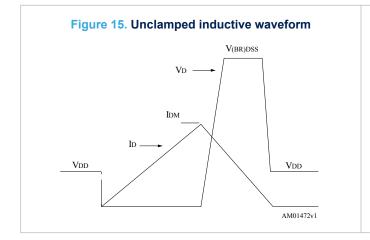


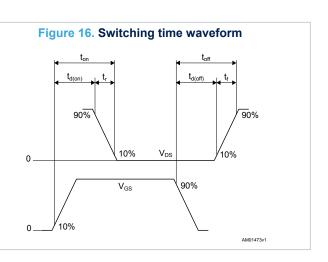
# 3 Test circuits









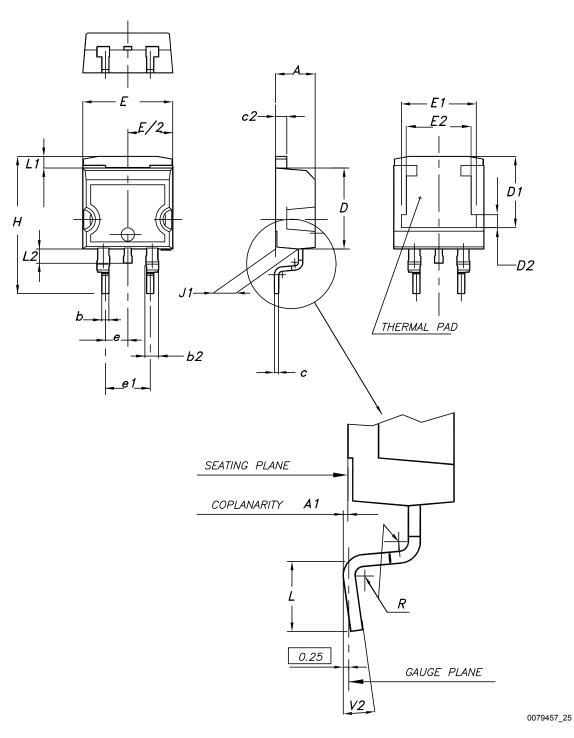


# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

# 4.1 D<sup>2</sup>PAK (TO-263) type A package information

## Figure 17. D<sup>2</sup>PAK (TO-263) type A package outline

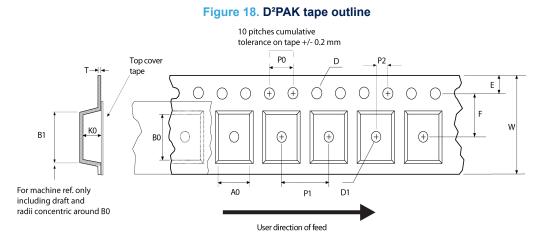


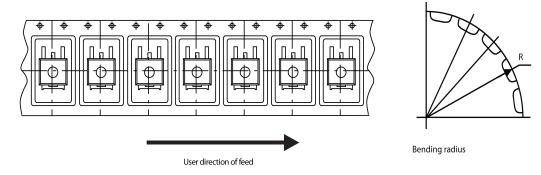
Dim.		mm	
Dim.	Min.	Тур.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50	7.75	8.00
D2	1.10	1.30	1.50
E	10.00		10.40
E1	8.30	8.50	8.70
E2	6.85	7.05	7.25
е		2.54	
e1	4.88		5.28
Н	15.00		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.40	
V2	0°		8°

## Table 8. D<sup>2</sup>PAK (TO-263) type A package mechanical data

# 4.2 D<sup>2</sup>PAK packing information

57

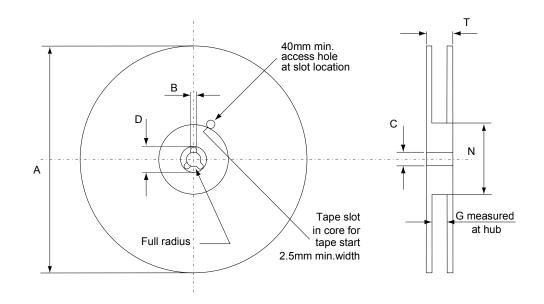




AM08852v1

DS3653 - Rev 7 Downloaded from Arrow.com.

## Figure 19. D<sup>2</sup>PAK reel outline



AM06038v1

## Table 9. D<sup>2</sup>PAK tape and reel mechanical data

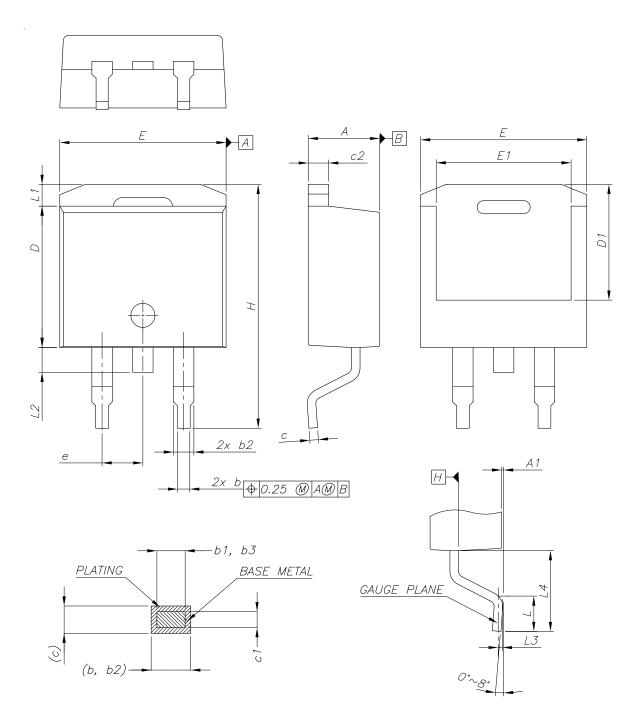
	Таре			Reel	
Dim.	n	nm	Dim.	m	m
Dim.	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base	quantity	1000
P2	1.9	2.1	Bulk c	quantity	1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			



# 4.3 D<sup>2</sup>PAK (TO-263) type B package information

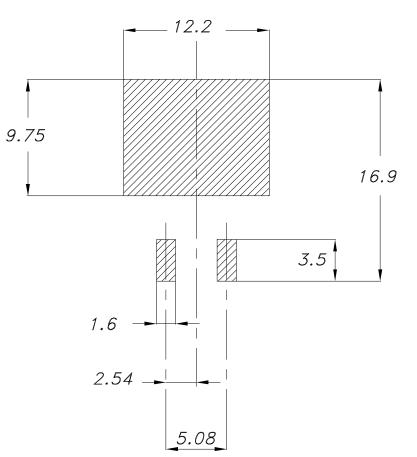
57

## Figure 20. D<sup>2</sup>PAK (TO-263) type B package outline



Dim		mm	
Dim.	Min.	Тур.	Max.
A	4.36		4.56
A1	0		0.25
b	0.70		0.90
b1	0.51		0.89
b2	1.17		1.37
b3	1.36		1.46
С	0.38		0.694
c1	0.38		0.534
c2	1.19		1.34
D	8.60		9.00
D1	6.90		7.50
E	10.15		10.55
E1	8.10		8.70
e		2.54 BSC	
Н	15.00		15.60
L	1.90		2.50
L1			1.65
L2			1.78
L3		0.25	
L4	4.78		5.28

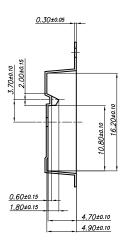
## Table 10. D<sup>2</sup>PAK (TO-263) type B mechanical data

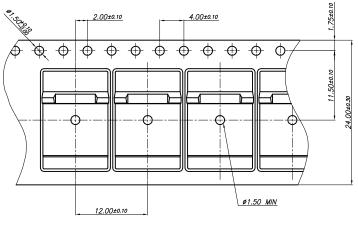


#### Figure 21. D<sup>2</sup>PAK (TO-263) recommended footprint (dimensions are in mm)

4.4 D<sup>2</sup>PAK type B packing information

## Figure 22. D<sup>2</sup>PAK type B tape outline



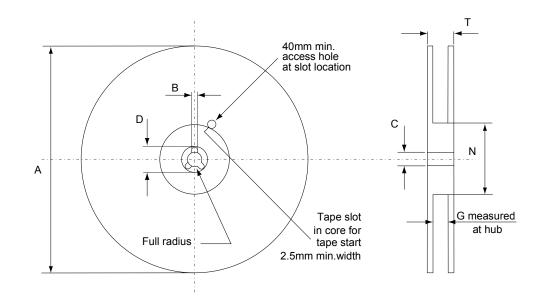




57

Footprint





AM06038v1

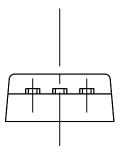
## Table 11. D<sup>2</sup>PAK type B reel mechanical data

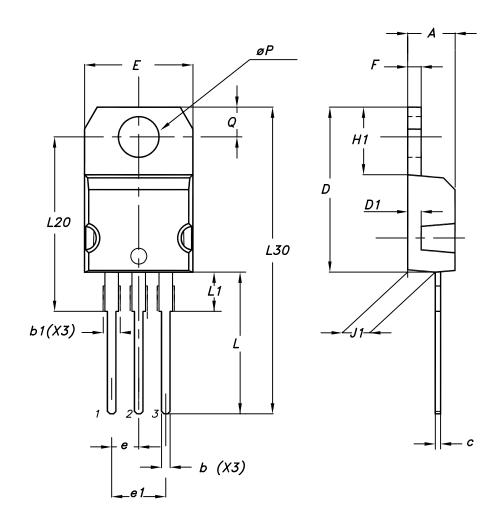
Dim.	mm		
	Min.	Max.	
А		330	
В	1.5		
С	12.8	13.2	
D	20.2		
G	24.4	26.4	
Ν	100		
Т		30.4	



# 4.5 TO-220 type A package information

Figure 24. TO-220 type A package outline





0015988\_typeA\_Rev\_21

Dim.	mm			
Dim.	Min.	Тур.	Max.	
A	4.40		4.60	
b	0.61		0.88	
b1	1.14		1.55	
С	0.48		0.70	
D	15.25		15.75	
D1		1.27		
E	10.00		10.40	
е	2.40		2.70	
e1	4.95		5.15	
F	1.23		1.32	
H1	6.20		6.60	
J1	2.40		2.72	
L	13.00		14.00	
L1	3.50		3.93	
L20		16.40		
L30		28.90		
øP	3.75		3.85	
Q	2.65		2.95	

## Table 12. TO-220 type A package mechanical data

# **Revision history**

Date	Version	Changes
09-Sep-2004	1	First release
10-Jun-2005	2	Typing error, wrong description
26-Jul-2006	3	The document has been reformatted, no content change
31-Aug-2006	4	Typo mistake on order code
21-Dec-2006	5	Various changes on "Test conditions" for Table 5. and Table 6.
12-Jan-2007	6	Order code has been corrected
01-Oct-2018	7	The part numbers STB11NM60-1 and STP11NM60FP have been moved to a separate datasheet and the document has been updated accordingly.
		Modified Table 1. Absolute maximum ratings, Table 2. Thermal data and Table 5. Dynamic.
		Modified Section 2.1 Electrical characteristics (curves).
		Updated Section 4 Package information.
		Minor text changes.

## Table 13. Document revision history



# Contents

1	Elect	rical ratings	2		
2	Electrical characteristics				
	2.1	Electrical characteristics (curves)	5		
3	Test	circuits	7		
4	Pack	age information	8		
	4.1	D <sup>2</sup> PAK (TO-263) type A package information	8		
	4.2	D <sup>2</sup> PAK packing information	10		
	4.3	D <sup>2</sup> PAK (TO-263) type B package information	12		
	4.4	D <sup>2</sup> PAK type B packing information	15		
	4.5	TO-220 type A package information	16		
Rev	ision I	nistory	19		



#### IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2018 STMicroelectronics – All rights reserved